Onsemi

MOSFET – Power, Single **N-Channel**

80 V, 13.1 mΩ, 42 A

NVMFS6H852NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low RDS(on) to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS6H852NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	80	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady $T_C = 25^{\circ}C$		I _D	42	А
Current R _{θJC} (Notes 1, 3)	State	T _C = 100°C		29	
Power Dissipation		$T_C = 25^{\circ}C$	PD	54	W
$R_{\theta JC}$ (Note 1)		$T_{C} = 100^{\circ}C$		27	
Continuous Drain Current R _{θJA}	Steady State	$T_A = 25^{\circ}C$	Ι _D	11	А
(Notes 1, 2, 3)	Otale	$T_A = 100^{\circ}C$		8	
Power Dissipation	$T_A = 25^{\circ}C$		PD	3.6	W
$R_{\theta JA}$ (Notes 1, 2)	T _A			1.8	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	208	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	– 55 to +175	°C
Source Current (Body Diode)			۱ _S	45	А
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 2.2 \text{ A}$)			E _{AS}	207	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	2.8	°C/W
Junction-to-Ambient - Steady State (Note 2)	R _{θJA}	42	

The entire application environment impacts the thermal resistance values shown, 1. they are not constants and are only valid for the particular conditions noted.

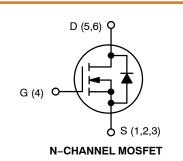
2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

Maximum current for pulses as long as 1 second is higher but is dependent З. on pulse duration and duty cycle.

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
00 V	13.1 mΩ @ 10 V	40.4	
80 V	17 mΩ @ 4.5 V	42 A	

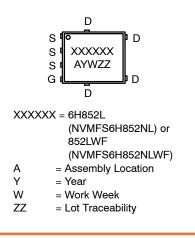




DFN5 (SO-8FL) CASE 488AA STYLE 1

DFNW5 (FULL-CUT SO8FL WF) CASE 507BA

MARKING DIAGRAM



ORDERING INFORMATION

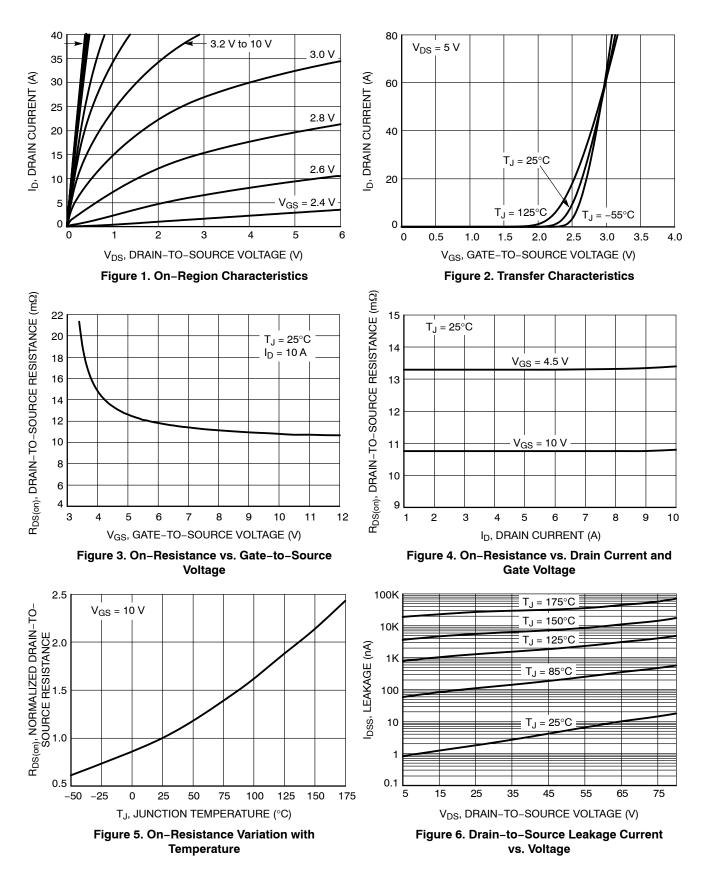
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

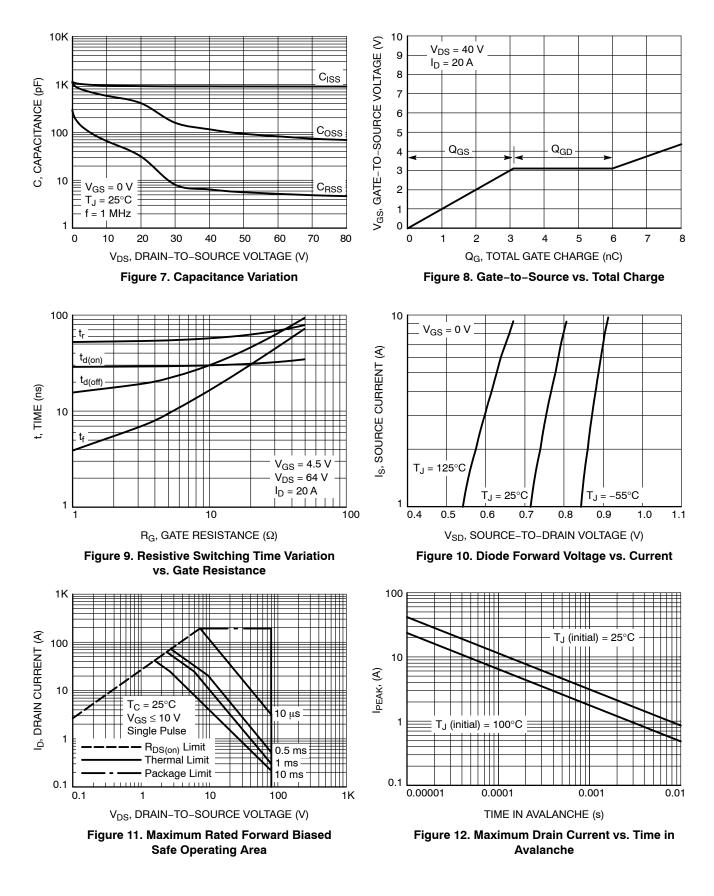
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_{D} = 250 μ A		80			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /				47.7		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$, $T_{J} = 25 °C$				10	μA
		V _{DS} = 80 V	T _J = 125°C			100	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	45 μΑ	1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.1		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A		10.8	13.1	mΩ
		V _{GS} = 4.5 V	I _D = 10 A		13.4	17.0	
Forward Transconductance	9 FS	V _{DS} =8 V, I _D = 2	20 A		55		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 40 V			906		pF
Output Capacitance	C _{OSS}				116		
Reverse Transfer Capacitance	C _{RSS}				6		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 40 V; I _D = 20 A			17		nC
Threshold Gate Charge	Q _{G(TH)}	V_{GS} = 4.5 V, V_{DS} = 40 V; I_{D} = 20 A			2		1
Gate-to-Source Charge	Q _{GS}				3.1		1
Gate-to-Drain Charge	Q _{GD}				2.9		1
Plateau Voltage	V _{GP}	1			3.1		V
Total Gate Charge	Q _{G(TOT)}				8		nC
SWITCHING CHARACTERISTICS (Note	5)				•		
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 64 V, I_{D} = 20 A, R_{G} = 2.5 Ω			29		ns
Rise Time	t _r				53		
Turn-Off Delay Time	t _{d(OFF)}				18		
Fall Time	t _f				6		
DRAIN-SOURCE DIODE CHARACTERIS	STICS						
Forward Diode Voltage	V _{SD}		$T_J = 25^{\circ}C$		0.81	1.2	V
-				0.68		1	
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/μs, I _S = 20 A		1	32		ns
Charge Time	t _a				20		1
Discharge Time	t _b				12		1
Reverse Recovery Charge	Q _{RR}				25		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (Continued)



TYPICAL CHARACTERISTICS (Continued)

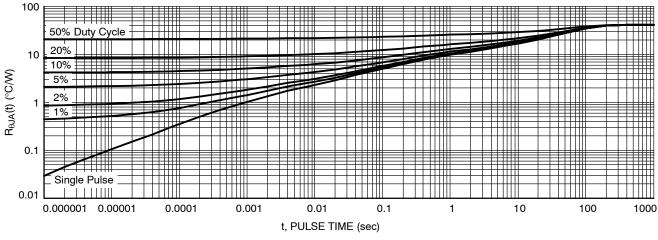


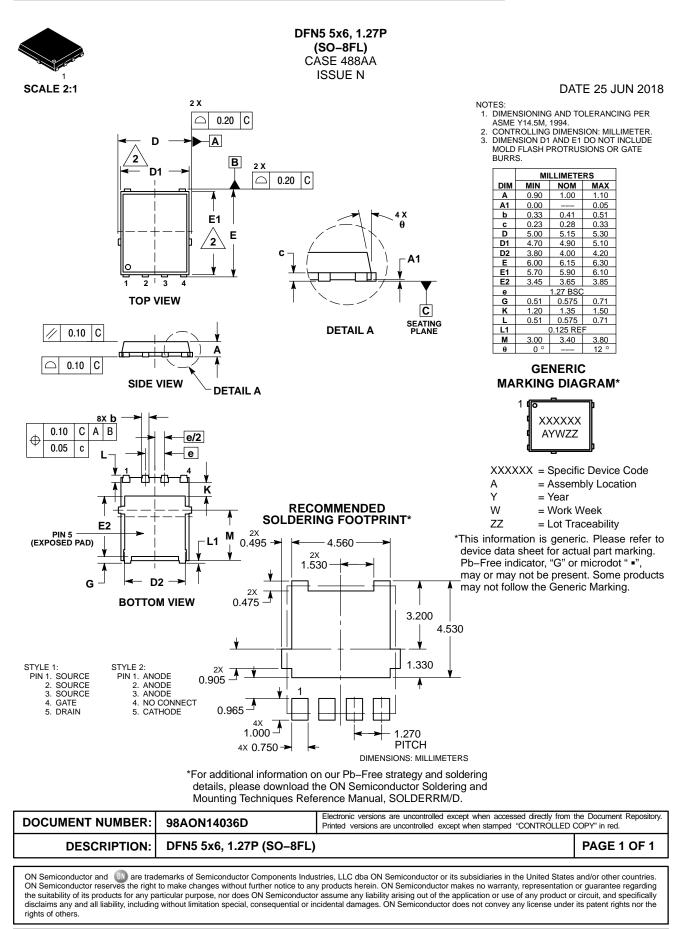
Figure 13. Thermal Response

DEVICE ORDERING INFORMATION

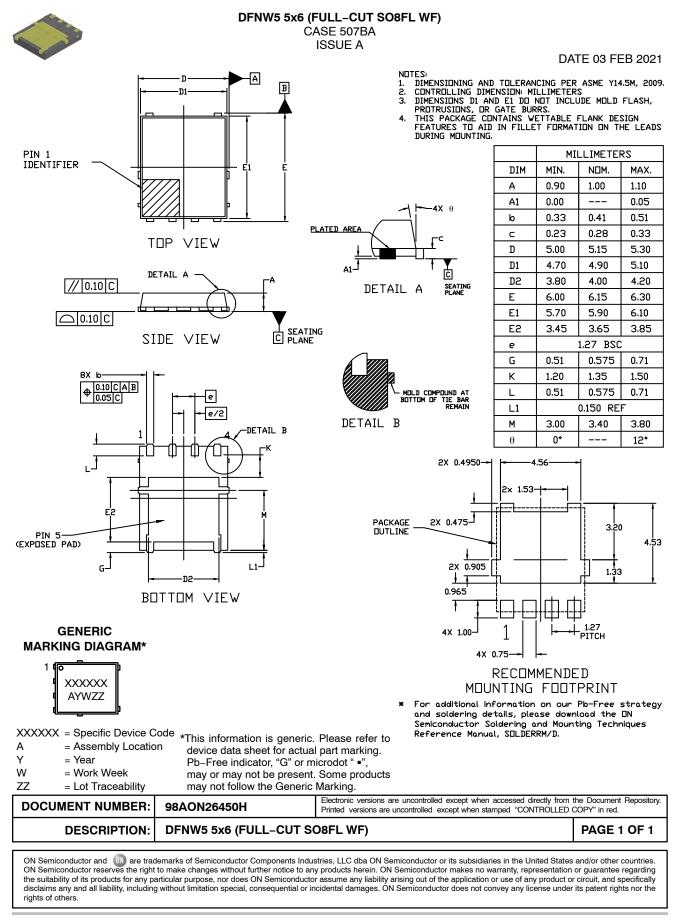
Device	Marking	Package	Shipping [†]
NVMFS6H852NLT1G	6H852L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS6H852NLWFT1G	852LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.









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